

HTdisplay ELECTRONICS CO.,LTD

华田信科电子有限公司 HTDISPLAY ELECTRONICS CO.,LTD.

The professional LCD manufacturer

	www.htdisplay.com	
SPE	CIFICATI	ONS
	Product Name: <u>LCN</u>	<u>M</u>
Model	PartNumber: HT2400	D28A-RTP
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1. Introduction

1.1 Scope of application

This specification applies to the positive type TFT transmissive dot matrix LCD module that is supplied by Tecenstar. This LCD module should be designed for mobile phone use.

LCD specification: Dots 240xRGBx320.

As to basic specification of the driver IC, refer to the IC(ILI9341V) specification and datasheet.

1.2 Structure:

Module display structure:

TFT Module + FPC + Touch Panel +BL+TP

FULL 65k or 262k Color 2.8 inch TFT LCD size for main LCD;

One bare chip with gold bump (COG) TECH;

8/16 BITS 80 parallel interface;

1.3 TFT features:

Structure: TFT PANNEL+IC+FPC+BL+TP; Transmissive Type LCD 240 dot-source and 320 dot-gate outputs; 65k or 262k Color can be selected by software; White LED back light; 8/16 BITS 80 parallel interface;

1.4 Applications:

Mobile phone

PSP

PDA

GPS

Etc...



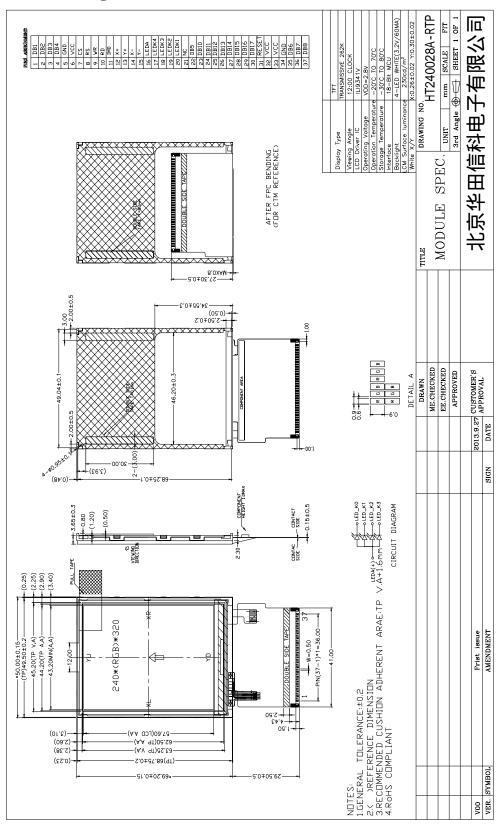
2. General specification

ITEM	Standard value	UNIT
LCD Type	TFT Transmissive	
Driver element	a-Si TFT Active matrix	
Number of Dots	240* (RGB) *320	Dots
Pixel Arrangement	RGB Vertical Stripe	
Active Area	43. 2 *57. 6	mm
Viewing Direction	6 0' clock	
Driver IC	ILI9341V	
Module Size(W*H*T)	50x69. 2x3. 65	mm
Approx. Weight	TBD	g
Back Light	White LED	
System interface	8/16 BITS 80 parallel interfac	e



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3. Mechanical drawing





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4. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	V_{cc}	-0.3	3.3	V
Input voltage for logic	V_{IN}	-0.5	V _{cc} +0.3	V
Supply current (One LED)	I _{LED}		30	mA
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Min	Тур	Max	Unit	Applicable terminal
Supply voltage for logic	V_{cc}	2.5	2.8	3.3	V	V_{DD}
Innut valtage	V _{IL}	-0.3	-	0.2 V _{DD}	V	
Input voltage	V _{IH}	0.8 V _{cc}	-	V _{cc}	V	
Input leakage current	I _{LKG}				μΑ	
LED Forward voltage	V _f	3.0	3.2	3.4	V	
Input backlight current	I _{LED}	-	15	20	mA	With One LED

Backlight driving conditions

Item	Symbol		Values	Unit	Remark	
item	Symbol	Min.	Тур.	Max.	Omt	Kemark
Voltage for LED backlight	$V_{\rm L}$	3.0	3.2	3.4	V	Note 1
Current for LED backlight	$I_{\rm L}$		60	80	mA	
LED life time	-	30,000	-	-	Hr	Note 2



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TOUCH PANEL SPECIFICATIONS

Electrical Characteristics

ITEM	SPECIFICATIONS			LINIT	REMARK	
I I EIVI	MIN.	TYP.	MAX	UNIT	KEIVIAKK	
Linearity	-1.5	-	1.5	%	After environment & life test	
Torminal Bosistanso	-	400	-	ohm	X(Film side)	
Terminal Resistance	300	-	500	ohm	Y(Glass side)	
Insulation Resistance	10	-	-	Mohm	DC 25V 1min	
Operating Voltage	-	5	-	V	DC	

Optical Characteristics

ITEM	SPECIFICATIONS			UNIT	REMARK	
I I EIVI	MIN. TYP		MAX	UNIT	KEIVIAKK	
Response Time	-	-	10	ms	100kohm pull-up	
Light Transparency	80	-	-	%		

Mechanical Characteristics

ITENA	S	PECIFICATION	LINIT	DENANDY		
ITEM	MIN.	TYP.	MAX	UNIT	REMARK	
Operation Force	-	100	-	gf	Note1	
Surface Hardness	3	=	-	Н		
Pen Sliding Durability	100,000			times	Note2	
Hitting Durability	1,000,000			times	Note3	

Note 1: Do not operate it with a thing except a polyacetal pen (tip R0.8mm or less) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

Depending on the pitch & the dimension of the spacer dots in between.

Note 2: Measurement for surface area.

-Scratch 100,000 times straight line on the film with a stylus change every 20,000 times.

-Force: 100gf. -Speed: 60mm/sec.

-Stylus: R0.8 polyacetal tip.

Note 3: Hit 1,000,000 times on the film with an R12.5mm tip.

-Force: 250gf. -Speed: 2 times/sec.

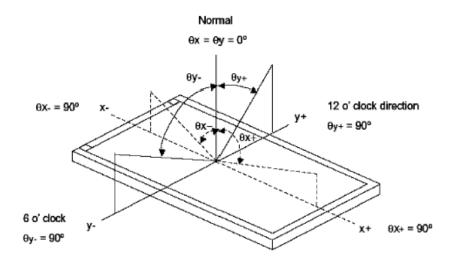


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6. OPTICAL CHARACTERISTICS

ITEM		CVNADOL	CONDITIONS	SPE	CIFICATI	ONS	UNIT	NOTE
		SYMBOL	INIBOL CONDITIONS		TYP.	MAX	UNIT	NOTE
Brightness		В			230		Cd/m ²	
Contrast Ratio)	CR		400	500			
Response Tim	ne	Tr+Tf			25	30	ms	
	Red	XR			0.649			
		YR	Viewing		0.323			
CIE	Green	XG	normal angle		0.289			All left side
Color		Y _G			0.588			data are based on TIANMA's
coordinate	Blue	Хв			0.133			
Coordinate		YB			0.133			product
	White	Xw			0.260			reference only
		Yw			0.300			
	Hor.	$\theta_{_{X+}}$		60	70			
Viewing		$\theta_{\scriptscriptstyle X-}$	Center CR>=10	60	70		Doo	
Angle	Ver.	$ heta_{\scriptscriptstyle{Y+}}$		60	70		Deg.	
		$ heta_{\scriptscriptstyle Y-}$		50	60]	
Uniformity	Un			80	85		%	

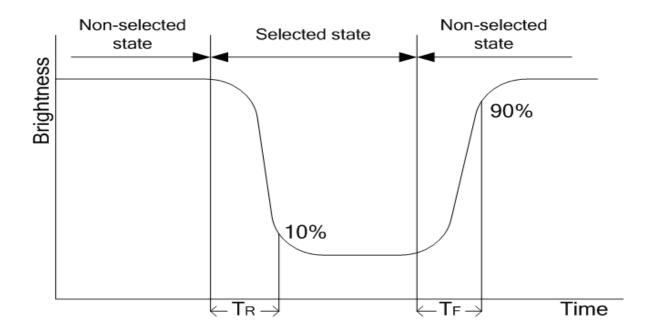
Note 1 : Definition of Viewing Angle xand ::





Note 2: Definition of contrast ratio CR:

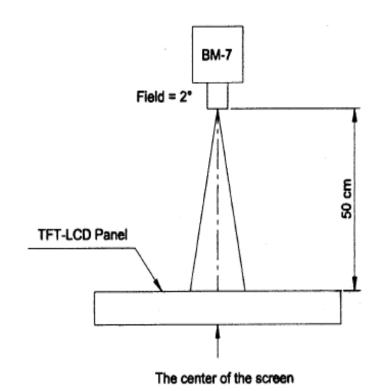
Note 3: Definition of response time (TR, TF)



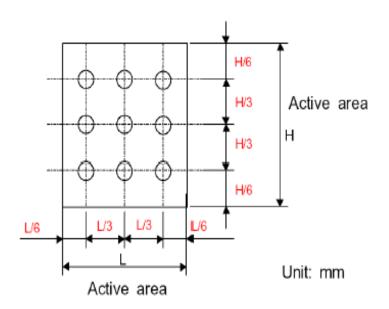


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The brightness test equipment setup 20mA Field=2° (As measuring "black" image, field=2° is the best testing condition)



Note 4:





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7. MCU Interface Pin Function

. Table 2: Pin assignment

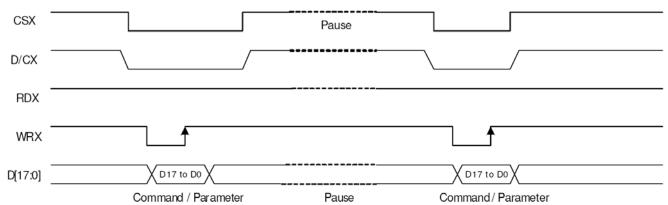
Pin No.	Symbol	Description
1~4	DB1~DB4	Data bus.
5	GND	Ground.
6	VCC	Power supply for logic voltage.
	, , ,	A chip select signal.
7	CS	Low: the ILI9341V is selected and accessible.
'	CS	High: the ILI9341Vis not selected and not accessible.
		A register select signal.
8	RS	Low: select signal. Low: select an index or status register,
0	KS	High: select a control register.
		A write strobe signal and enables an operation to write data when
9	WR	the signal is low.
1.0		A read strobe signal and enables an operation to read out data
10	RD	when the signal is low.
11	IM0	Interface select _o IM0=0 : 16BIT; IM0=1 : 8BIT
12	X+	Touch panel pin
13	Y+	Touch panel pin
14	X-	Touch panel pin
15	Y-	Touch panel pin
16	LEDA	Anode of LED backlight.
17	LEDK1	Cathode of LED backlight.
18	LEDK2	Cathode of LED backlight.
19	LEDK3	Cathode of LED backlight.
20	LEDK4	Cathode of LED backlight.
21	NC	No connection.
22	DB5	Data bus.
23~30	DB10~DB17	Data bus.
		A reset pin.
31	RESET	Initializes the ILI9341V with a low input.
	KESET	Be sure to execute a power-on reset after supplying power.
32	VCC	Power supply for analog voltage.
33	VCC	Power supply for logic voltage.
34	GND	Ground.
35~37	DB6~DB8	Data bus.



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Timing characteristics

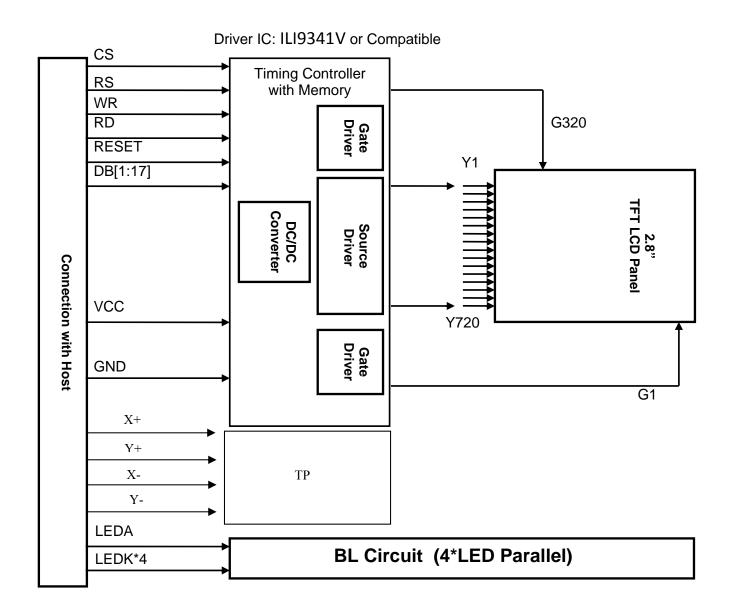
Parallel interface pause





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8. BLOCK DIAGRAM





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9. Standard Specification for Reliability 9–1. Standard Specifications for Reliability of LCD Module

No	Item	Description
01	High temperature operation	The sample should be allowed to stand at 70°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at -20°C for 120 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at 60°C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles: -30°C for 30 minutes → normal temperature for 5 minutes → +80°C for 30 minutes → normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range: 10Hz ~ 55Hz Amplitude of vibration: 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.
08	Packing drop test	According to ASTM-D-5327.
09	Electrical Static Discharge	Air: ± 4 KV 150pF/330 Ω 5 times
*5	Discharge	Contact: $\pm 2KV 150pF/330\Omega 5$ time

^{*}Sample size for each test item is 3~5pcs



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9 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 9.2, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

9-3. MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25 \pm 5 $^{\circ}$ C), normal humidity (50 \pm 10% RH), and in area not exposed to direct sun light.

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10. Specification of Quality Assurance:

10-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by TeCenTer

10-2. Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

- (i) Test method: According to MIL-STD105E.General Inspection Level II take a single time.
- (ii) The defects classify of AQL as following:

Major defect: AQL = 0.65 Minor defect: AQL = 2.5 Total defects: AQL = 2.5

- 10-3. Non- conforming Analysis & Deal With Manners
- a. Non-conforming Analysis:
- (i) Purchaser should supply the detail data of non- conforming sample and the non- conforming.
- (ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.
 - (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
 - b. Disposition of non- conforming:
 - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
 - (ii) Both supplier and customer should analyze the reason and discuss the disposition of non- conforming when the reason of nonconforming is not sure.

10-4. Agreement items

Both sides should discuss together when the following problems happen.

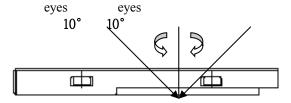
- a. There is any problem of standard of quality assurance, and both sides should think that must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.



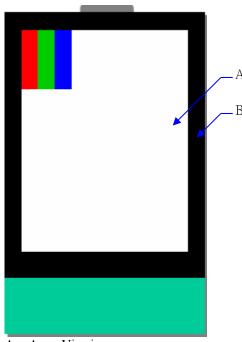
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10-5. Standard of The Product Appearance Test

- a. Manner of appearance test:
- (i) The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- (ii) When test the model of transmissive product must add the reflective plate.
- (iii)The test direction is base on around 10° of vertical line.
- (iiii)Temperature: 25±5°C Humidity: 60±10%RH



(iv) Definition of area:

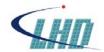


- A. Area: Viewing area.
- B. Area: Out of viewing area. (Outside viewing area)
- b. Basic principle:
- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)

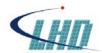


10-6. Inspection specification

NO	Item	Criterion	AQL	
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker		
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	 2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm. 		
03	LCD and Touch Panel black spots, white spots, contamination (non – display)	3.1 Round type: As following drawing $\Phi = (X+Y)/2$ $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5	
		3.2 Line type: (As following drawing) Length(m Width(mm) Acceptable Q'ty m) W ≤ 0.02 Accept no dense L ≤ 3.0 0.02 <w <math="">\leq 0.05 L ≤ 2.5 0.03<w <math="">\leq 0.08 2 0.08<w *="" 3mm.<="" densely="" lines="" more="" no="" rejection="" spaced:="" td="" than="" two="" within="" =""><td>2.5</td></w></w></w>	2.5	



NO	Item	Criterion			AQL
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ(mm) $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q'ty	Acceptable Q'ty Accept no dense 3 2 0 3	2.5
05	Scratches	Follow NO.3 -2 Line Type.			
06	Chipped glass	Symbols: x: Chip length y: Chip width z: Chip k: Seal width t: Glass thickness a: LC L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between the control of the co	ween panels: x: Chip leving area $x \le x \le$	1/8a 1/8a	2.5



NO	Item	Criterion			
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:			
		y: Chip width x: Chip length z: Chip thickness			
		$y \le 0.5 \text{mm}$ $x \le 1/8 a$ $0 < z \le t$ 7.2.2			
		Non-conductive portion:			
07	Glass crack	y Z Z X X	2.5		
		y: Chip width x: Chip length z: Chip thickness			
		$y \le L \qquad \qquad x \le 1/8a \qquad \qquad 0 < z \le t$			
		 If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. If the product will be heat sealed by the customer, the alignment mark must mot be damaged. 7.2.3 Substrate protuberance and internal crack 			
		y: width x: length			
		$y \le 1/3L$ $X \le a$			



NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	 9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong. 	2.5 2.5 0.65
10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	 11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart. 	2.5 2.5 2.5 2.5 0.65
12	FPC	12.1 FPC terminal damage \leq 1/2 FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage \leq 1/2 alignment area and can not affect the function , we judge accept.	2.5 2.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle.13.2 No short circuits in components on PCB or FPC.	2.5 0.65



NO	Item	Criterion A				AQL
14	Touch Panel Chipped glass	k: Seal width t: Toud L: Electrode pad length 14.1 General glass chip: 14.1.1 Chip on panel sur z: Chip thickness Z≦t ○ Unit: mm	y: Chip width ≤ 1/2 k and not over viewing area	ls: x : Chip length $x \le 1/8a$		2.5
		z : Chip thickness $z \le t$ ① Unit: mm ① If there are 2 or more	y: Chip width ≤ 1/2 k and not over viewing area chips, x is the total length of	x : Chip length $x \le 1/8a$ each chip		



NO	Item	Criterion	AQL
15	Touch Panel(Fish eye、dent and bubble on film)		2.5
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$), it is acceptable.	2.5
17	Touch Panel Linearity	Less than 2.5% is acceptable.	2.5
18	LCD Ripple	Touch the touch panel, can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2.5
19	General appearance	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 	0.65 0.65 0.65 0.65

11. Handling Precaution:

11-1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance. Must not lick and swallow. when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

11-2 Storage

- Store in an ambient temperature of 25±10°C, and in a relative humidity of 50±10%RH. Don't expose to sunlight or fluorescent light.
- Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

11-3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: No higher than 280±10°C and less than 3 sec during Hand soldering.
- Rewiring: no more than 2 times.

12. Packing method

----TBD